



Vincotech

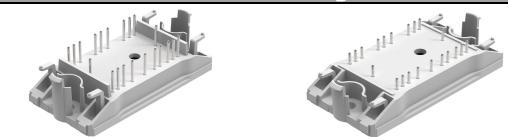
V23990-P861-F49-PM

V23990-P861-F48-PM

datasheet

flow PACK 0**600 V / 10 A****Features**

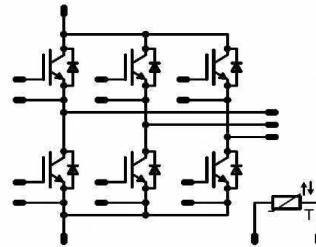
- 2 clip housing in 12 mm and 17 mm height
- Trench Fieldstop IGBT³ technology
- Compact and low inductance design
- Built-in NTC

flow 0 housing**Target Applications**

- Motor Drives
- Power Generation
- UPS

Types

- V23990-P861-F49-PM
- V23990-P861-F48-PM

Schematic**Maximum Ratings** $T_j = 25^\circ\text{C}$, unless otherwise specified

| Parameter | Symbol | Condition | Value | Unit |
|-----------------------------------|----------------------|--|----------|--------------------|
| Inverter Transistor | | | | |
| Collector-emitter voltage | V_{CE} | | 600 | V |
| DC collector current | I_C | | 10 | A |
| Repetitive peak collector current | I_{CRM} | t_p limited by T_{jmax} | 30 | A |
| Power dissipation | P_{tot} | $T_j = T_{jmax}$ | 40 | W |
| Gate-emitter peak voltage | V_{GE} | | ± 20 | V |
| Short circuit ratings* | t_{SC} V_{CC} | $T_j \leq 150^\circ\text{C}$ $V_{GE} = 15\text{ V}$ | 6 360 | μs V |
| Maximum Junction Temperature | T_{jmax} | | 175 | $^\circ\text{C}$ |

* It is recommended to not exceed 1000 short circuit situations in the lifetime of the module and to allow at least 1s between short circuits

Inverter Diode

| | | | | |
|---------------------------------|------------|-----------------------------|-----|------------------|
| Peak Repetitive Reverse Voltage | V_{RRM} | | 600 | V |
| DC forward current | I_F | | 10 | A |
| Repetitive peak forward current | I_{FRM} | t_p limited by T_{jmax} | 20 | A |
| Power dissipation | P_{tot} | $T_j = T_{jmax}$ | 32 | W |
| Maximum Junction Temperature | T_{jmax} | | 175 | $^\circ\text{C}$ |

Thermal properties

| | | | | |
|--------------------------------|-----------|--|--------------------------|------------------|
| Storage temperature | T_{stg} | | -40.....+125 | $^\circ\text{C}$ |
| Operation junction temperature | T_{op} | | -40.....+ T_{jmax} -25 | $^\circ\text{C}$ |



Vincotech

V23990-P861-F49-PM**V23990-P861-F48-PM**

datasheet

Maximum Ratings

$T_j = 25^\circ\text{C}$, unless otherwise specified

| Parameter | Symbol | Condition | Value | Unit |
|------------------------------|-------------------|---|----------|------|
| Insulation properties | | | | |
| Insulation voltage | V_{isol} | DC Test Voltage* $t_p = 2 \text{ s}$ | 6000 | V |
| | | AC Voltage $t_p = 1 \text{ min}$ | 2500 | V |
| Creepage distance | | | min.12,7 | mm |
| Clearance | | 12mm height | 9,22 | mm |
| | | 17mm height | min.12,7 | mm |
| Comparative Tracking Index | CTI | | >200 | |

*100% tested in production

Characteristic Values

| Parameter | Symbol | Conditions | | | | | | Value | | | Unit |
|-----------|--------|--------------|-----------|-----------|------------|--------------|--------------|-----------|-----------|-----|------|
| | | V_{GE} [V] | V_r [V] | I_c [A] | T_i [°C] | V_{GS} [V] | V_{CE} [V] | I_t [A] | I_D [A] | Min | |

Inverter Transistor

| | | | | | | | | | | |
|---|---------------|---|----------|-----|---------|-----------|--------------|--------------|------|-----|
| Gate emitter threshold voltage | $V_{GE(th)}$ | $V_{CE} = V_{GE}$ | | | 0,00015 | 25 | 5 | 5,8 | 6,5 | V |
| Collector-emitter saturation voltage | V_{CESat} | | | | 10 | 25 150 | | 1,54 1,79 | 2,15 | V |
| Collector-emitter cut-off current incl. Diode | I_{CES} | | 0 | 600 | | 25 | | | 80 | μA |
| Gate-emitter leakage current | I_{GES} | | 20 | 0 | | 25 | | | 350 | nA |
| Integrated Gate resistor | R_{gint} | | | | | | | none | | Ω |
| Turn-on delay time | $t_{d(on)}$ | $R_{gon} = 32 \Omega$ $R_{goff} = 32 \Omega$ | ± 15 | 300 | 10 | 25 150 | 74 73 | | | ns |
| Rise time | t_r | | | | | 25 150 | 12 17 | | | |
| Turn-off delay time | $t_{d(off)}$ | | | | | 25 150 | 109 129 | | | |
| Fall time | t_f | | | | | 25 150 | 100 118 | | | |
| Turn-on energy loss | E_{on} | | | | | 25 150 | 0,16 0,21 | | | mWs |
| Turn-off energy loss | E_{off} | | | | | 25 150 | 0,23 0,30 | | | |
| Input capacitance | C_{ies} | | | | | | | 551 | | |
| Output capacitance | C_{oss} | | | | | | | 40 | | pF |
| Reverse transfer capacitance | C_{rss} | $f = 1 \text{ MHz}$ | 0 | 25 | 25 | | | 17 | | |
| Gate charge | Q_G | | | | | 15 | 480 | 10 | 25 | |
| Thermal resistance chip to heatsink | $R_{th(j-s)}$ | | | | | | | | 62 | nC |
| | | | | | | | | | | |
| | | | | | | | | | 2,38 | |
| | | | | | | | | | | K/W |

Inverter Diode

| | | | | | | | | | | |
|---------------------------------------|----------------------|-----------------------|----------|-----|----|-----------|--|--------------|------|------|
| Diode forward voltage | V_F | | | | 10 | 25 150 | | 1,61 1,56 | 2,2 | V |
| Peak reverse recovery current | I_{RRM} | $R_{gon} = 32 \Omega$ | ± 15 | 300 | 10 | 25 150 | | 9,69 11,5 | | A |
| Reverse recovery time | t_{rr} | | | | | 25 150 | | 143 158 | | ns |
| Reverse recovered charge | Q_{rr} | | | | | 25 150 | | 0,49 0,90 | | μC |
| Peak rate of fall of recovery current | $(di_{rf}/dt)_{max}$ | | | | | 25 150 | | 402 120 | | A/ms |
| Reverse recovered energy | E_{rec} | | | | | 150 | | 0,2 | | mWs |
| Thermal resistance chip to heatsink | $R_{th(j-s)}$ | | | | | | | | 2,97 | |
| | | | | | | | | | | K/W |

Thermistor

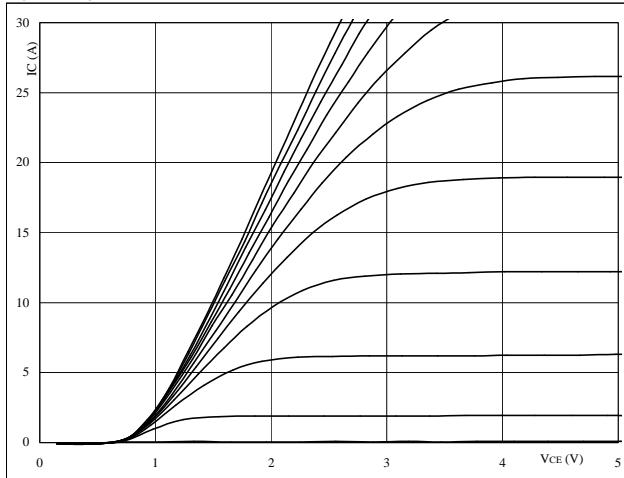
| | | | | | | | | | | |
|----------------------------|----------------|-------------------------|--|--|--|-----|----|------|----|------|
| Rated resistance | R | | | | | 25 | | 22 | | kΩ |
| Deviation of R_{100} | $\Delta R/R$ | $R_{100} = 1486 \Omega$ | | | | 100 | -5 | | +5 | % |
| Power dissipation | P | | | | | 25 | | 210 | | mW |
| Power dissipation constant | | | | | | 25 | | 4,4 | | mW/K |
| B-value | $B_{(25/50)}$ | Tol. -13,1% | | | | 25 | | 3940 | | K |
| B-value | $B_{(25/100)}$ | Tol. +11,6% | | | | 25 | | 4000 | | K |
| Vincotech NTC Reference | | | | | | | | | A | |

Output Inverter

figure 1
Typical output characteristics

IGBT

$$I_C = f(V_{CE})$$

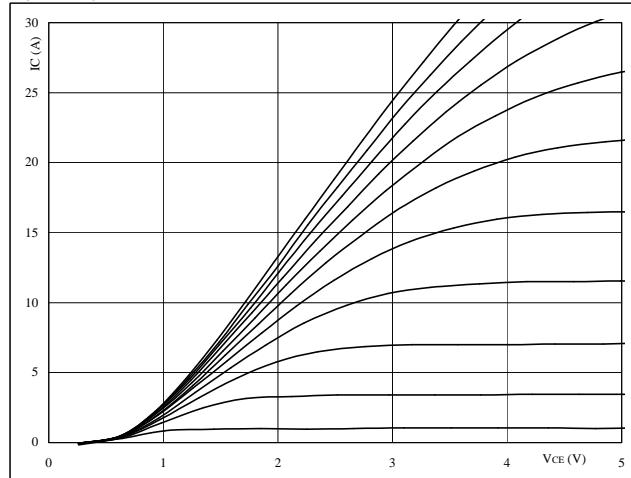


$t_p = 250 \mu s$
 $T_j = 25 {}^\circ C$
 V_{GE} from 7 V to 17 V in steps of 1 V

figure 2
Typical output characteristics

IGBT

$$I_C = f(V_{CE})$$

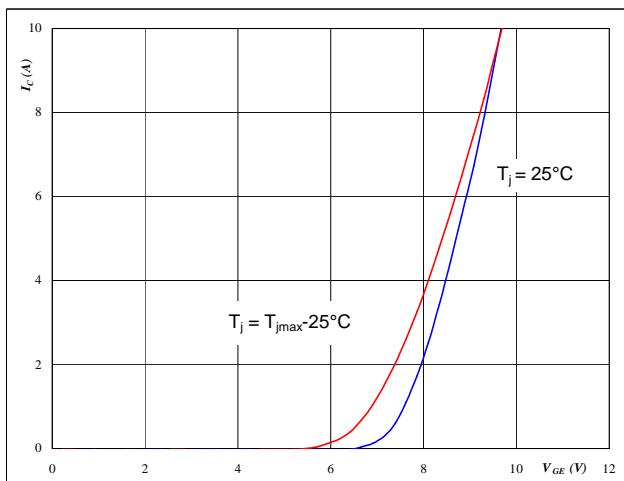


$t_p = 250 \mu s$
 $T_j = 150 {}^\circ C$
 V_{GE} from 7 V to 17 V in steps of 1 V

figure 3
Typical transfer characteristics

IGBT

$$I_C = f(V_{GE})$$

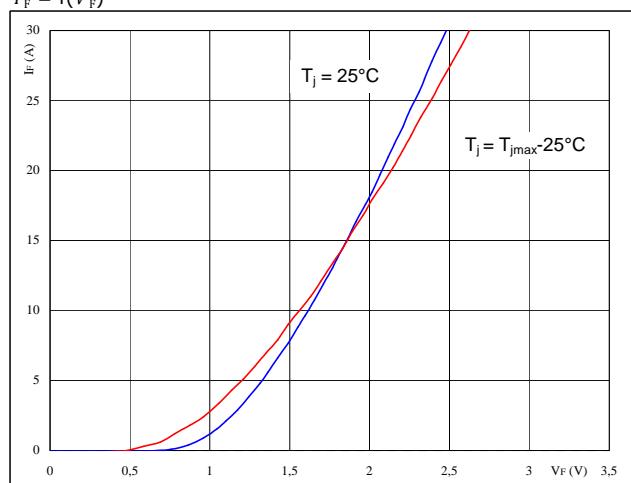


$t_p = 250 \mu s$
 $V_{CE} = 10 V$

figure 4
Typical diode forward current as a function of forward voltage

FWD

$$I_F = f(V_F)$$



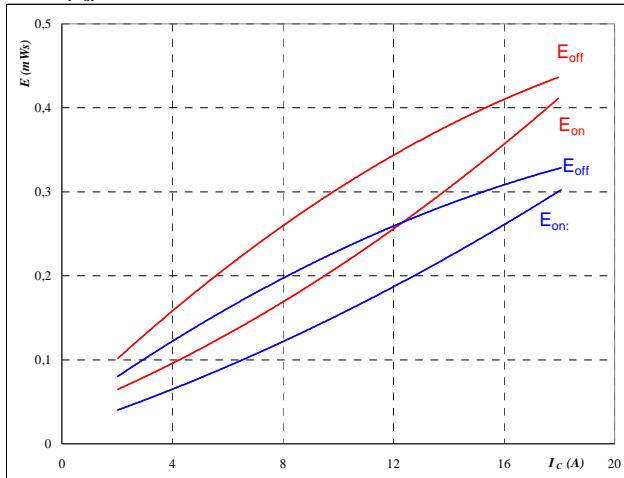
$t_p = 250 \mu s$

Output Inverter

figure 5

**Typical switching energy losses
as a function of collector current**

$$E = f(I_C)$$



inductive load

$$T_j = 25/150 \quad ^\circ\text{C}$$

$$V_{CE} = 300 \quad \text{V}$$

$$V_{GE} = \pm 15 \quad \text{V}$$

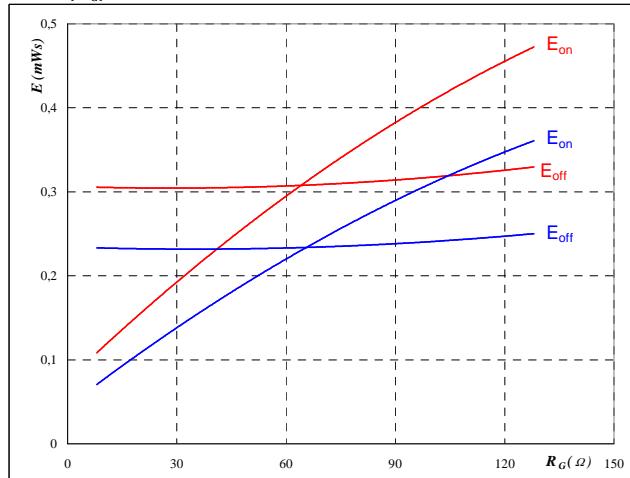
$$R_{gon} = 32 \quad \Omega$$

$$R_{goff} = 32 \quad \Omega$$

IGBT**figure 6**

**Typical switching energy losses
as a function of gate resistor**

$$E = f(R_G)$$



inductive load

$$T_j = 25/150 \quad ^\circ\text{C}$$

$$V_{CE} = 300 \quad \text{V}$$

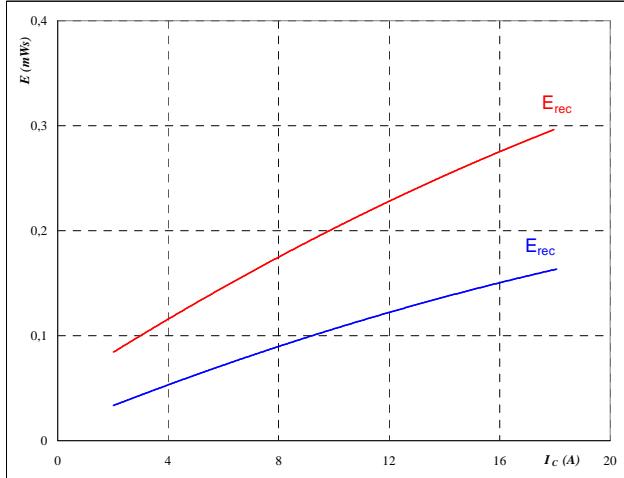
$$V_{GE} = \pm 15 \quad \text{V}$$

$$I_C = 10 \quad \text{A}$$

IGBT**figure 7**

**Typical reverse recovery energy loss
as a function of collector current**

$$E_{rec} = f(I_C)$$



inductive load

$$T_j = 25/150 \quad ^\circ\text{C}$$

$$V_{CE} = 300 \quad \text{V}$$

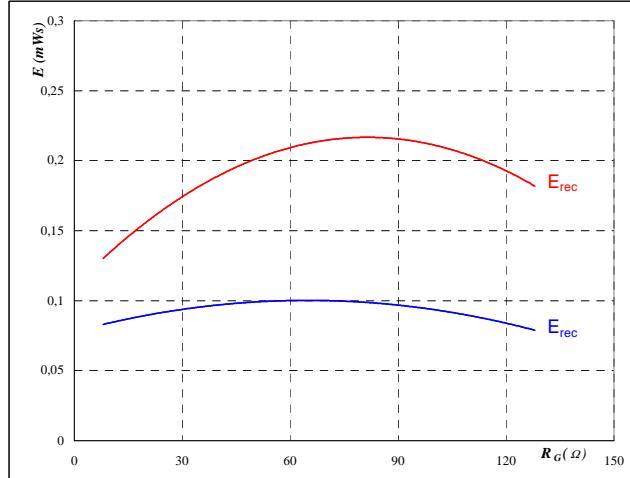
$$V_{GE} = \pm 15 \quad \text{V}$$

$$R_{gon} = 32 \quad \Omega$$

IGBT**figure 8**

**Typical reverse recovery energy loss
as a function of gate resistor**

$$E_{rec} = f(R_G)$$



inductive load

$$T_j = 25/150 \quad ^\circ\text{C}$$

$$V_{CE} = 300 \quad \text{V}$$

$$V_{GE} = \pm 15 \quad \text{V}$$

$$I_C = 10 \quad \text{A}$$

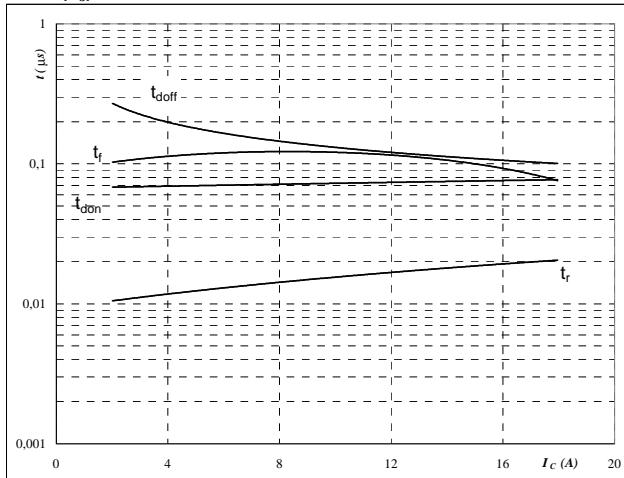
IGBT

Output Inverter

figure 9

Typical switching times as a function of collector current

$$t = f(I_C)$$



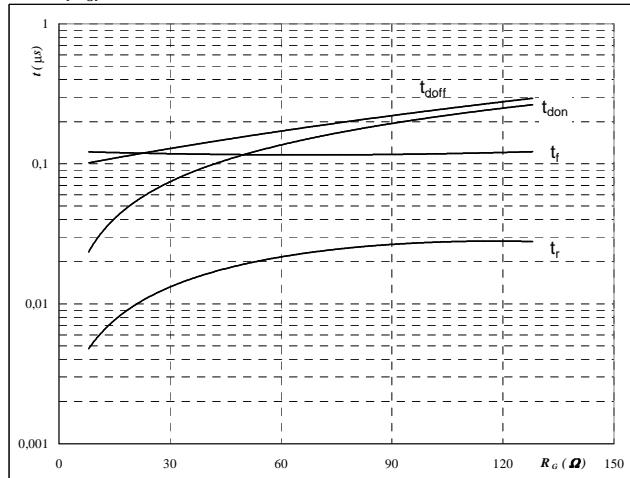
inductive load

$$\begin{aligned} T_j &= 150 \quad ^\circ\text{C} \\ V_{CE} &= 300 \quad \text{V} \\ V_{GE} &= \pm 15 \quad \text{V} \\ R_{gon} &= 32 \quad \Omega \\ R_{goff} &= 32 \quad \Omega \end{aligned}$$

IGBT**figure 10**

Typical switching times as a function of gate resistor

$$t = f(R_G)$$



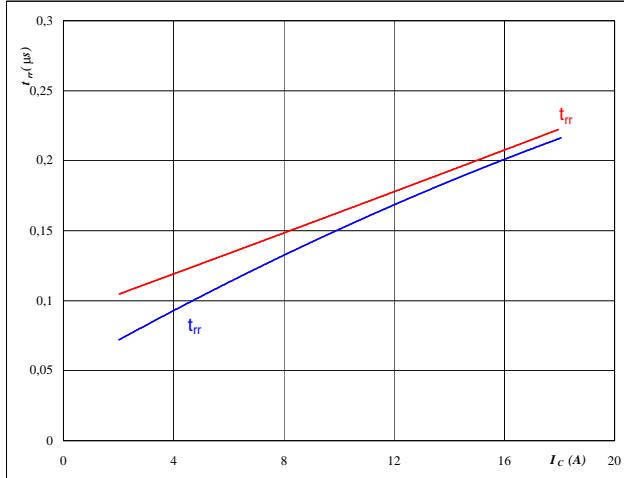
inductive load

$$\begin{aligned} T_j &= 150 \quad ^\circ\text{C} \\ V_{CE} &= 300 \quad \text{V} \\ V_{GE} &= \pm 15 \quad \text{V} \\ I_C &= 10 \quad \text{A} \end{aligned}$$

figure 11**FWD**

Typical reverse recovery time as a function of collector current

$$t_{rr} = f(I_C)$$

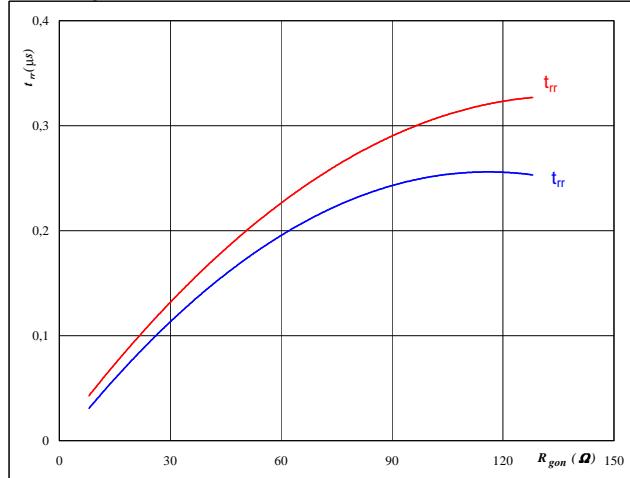


$$\begin{aligned} T_j &= 25/150 \quad ^\circ\text{C} \\ V_{CE} &= 300 \quad \text{V} \\ V_{GE} &= \pm 15 \quad \text{V} \\ R_{gon} &= 32 \quad \Omega \end{aligned}$$

figure 12**FWD**

Typical reverse recovery time as a function of IGBT turn on gate resistor

$$t_{rr} = f(R_{gon})$$



$$\begin{aligned} T_j &= 25/150 \quad ^\circ\text{C} \\ V_R &= 300 \quad \text{V} \\ I_F &= 10 \quad \text{A} \\ V_{GE} &= \pm 15 \quad \text{V} \end{aligned}$$

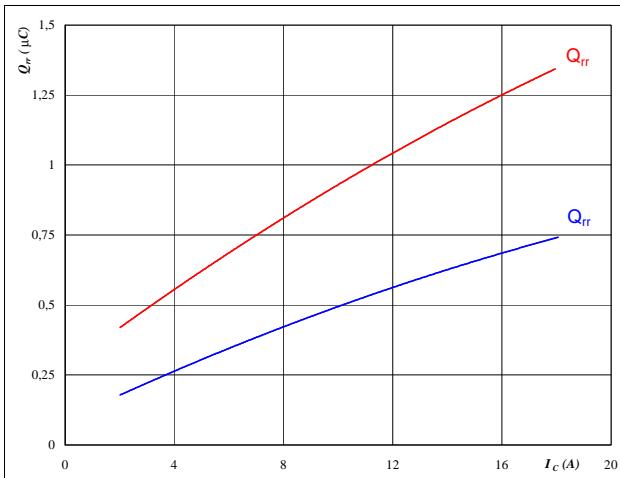
Output Inverter

figure 13

FWD

Typical reverse recovery charge as a function of collector current

$$Q_{rr} = f(I_c)$$



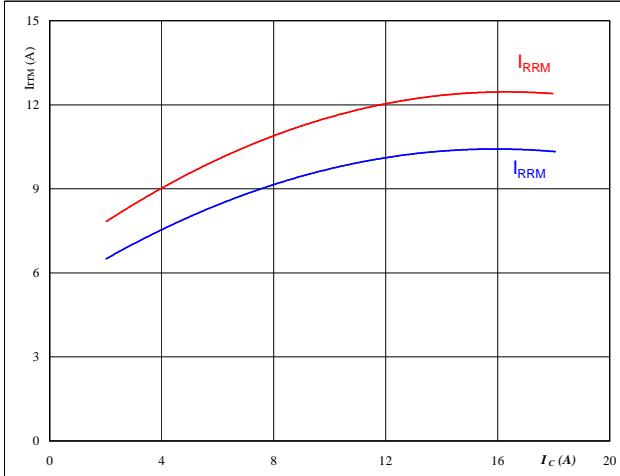
$T_j = 25/150 \text{ } ^\circ\text{C}$
 $V_{CE} = 300 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $R_{gon} = 32 \Omega$

figure 15

FWD

Typical reverse recovery current as a function of collector current

$$I_{RRM} = f(I_c)$$



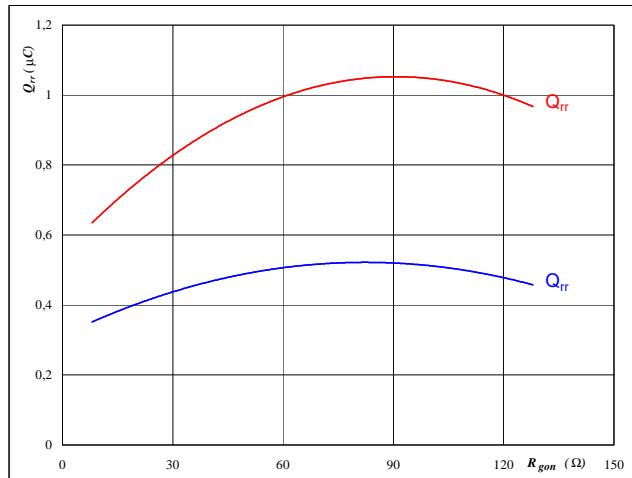
$T_j = 25/150 \text{ } ^\circ\text{C}$
 $V_{CE} = 300 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $R_{gon} = 32 \Omega$

figure 14

FWD

Typical reverse recovery charge as a function of IGBT turn on gate resistor

$$Q_{rr} = f(R_{gon})$$



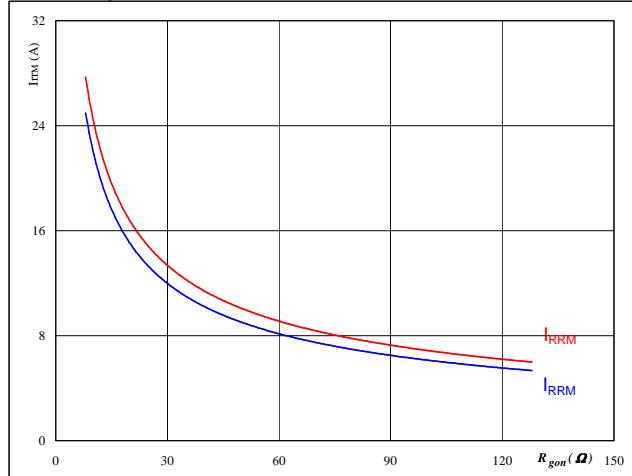
$T_j = 25/150 \text{ } ^\circ\text{C}$
 $V_R = 300 \text{ V}$
 $I_F = 10 \text{ A}$
 $V_{GE} = \pm 15 \text{ V}$

figure 16

FWD

Typical reverse recovery current as a function of IGBT turn on gate resistor

$$I_{RRM} = f(R_{gon})$$



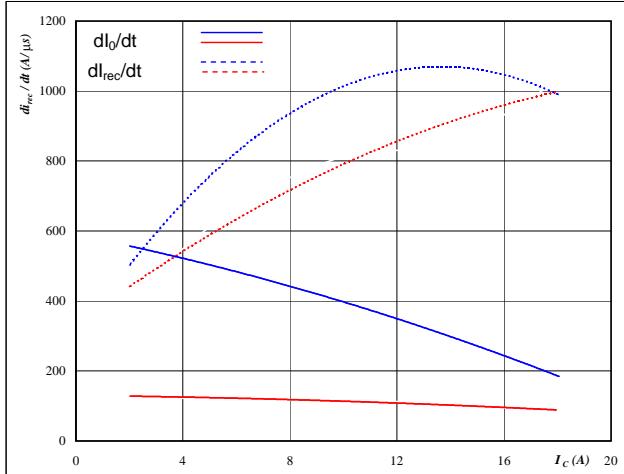
$T_j = 25/150 \text{ } ^\circ\text{C}$
 $V_R = 300 \text{ V}$
 $I_F = 10 \text{ A}$
 $V_{GE} = \pm 15 \text{ V}$

Output Inverter

figure 17

FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current
 $dI_0/dt, dI_{rec}/dt = f(I_c)$

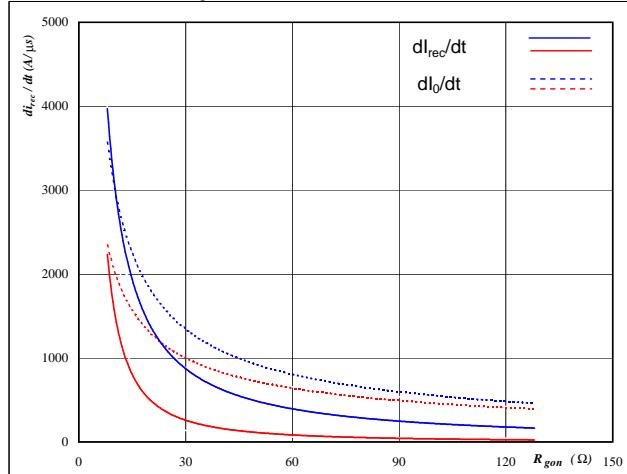


$T_j = 25/150 \text{ } ^\circ\text{C}$
 $V_{CE} = 300 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $R_{gon} = 32 \Omega$

figure 18

FWD

Typical rate of fall of forward and reverse recovery current as a function of IGBT turn on gate resistor
 $dI_0/dt, dI_{rec}/dt = f(R_{gon})$



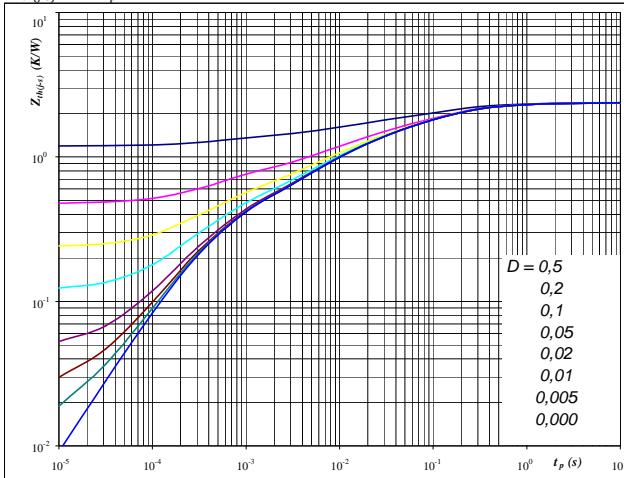
$T_j = 25/150 \text{ } ^\circ\text{C}$
 $V_R = 300 \text{ V}$
 $I_F = 10 \text{ A}$
 $V_{GE} = \pm 15 \text{ V}$

figure 19

IGBT

IGBT transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$
 $R_{th(j-s)} = 2,38 \text{ K/W}$

IGBT thermal model values

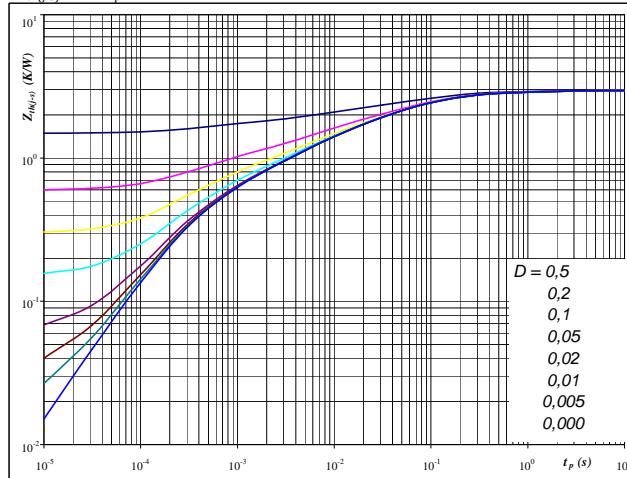
| R (K/W) | Tau (s) |
|-----------|----------|
| 3,75E-02 | 7,36E+00 |
| 2,27E-01 | 6,41E-01 |
| 8,06E-01 | 1,13E-01 |
| 6,21E-01 | 1,82E-02 |
| 3,77E-01 | 3,63E-03 |
| 3,09E-01 | 3,98E-04 |

figure 20

FWD

FWD transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$
 $R_{th(j-s)} = 2,97 \text{ K/W}$

FWD thermal model values

| R (K/W) | Tau (s) |
|-----------|----------|
| 5,11E-02 | 8,13E+00 |
| 2,21E-01 | 6,58E-01 |
| 9,53E-01 | 8,58E-02 |
| 7,53E-01 | 1,75E-02 |
| 5,64E-01 | 2,91E-03 |
| 4,29E-01 | 3,34E-04 |

Output Inverter

figure 21

IGBT

Safe operating area as a function of collector-emitter voltage

$$I_C = f(V_{CE})$$



D = single pulse

T_s = 80 °C

V_{GE} = ±15 V

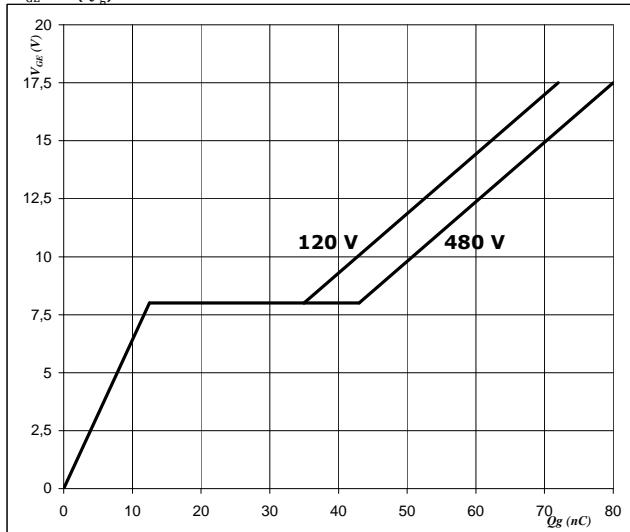
T_j = T_{jmax}

figure 22

IGBT

Gate voltage vs Gate charge

$$V_{GE} = f(Q_g)$$



I_C = 10 A

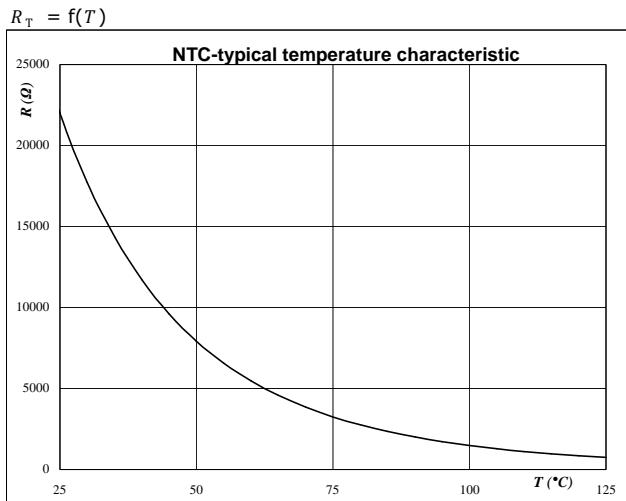
Thermistor

figure 1

Thermistor

Typical NTC characteristic as a function of temperature

$$R_T = f(T)$$



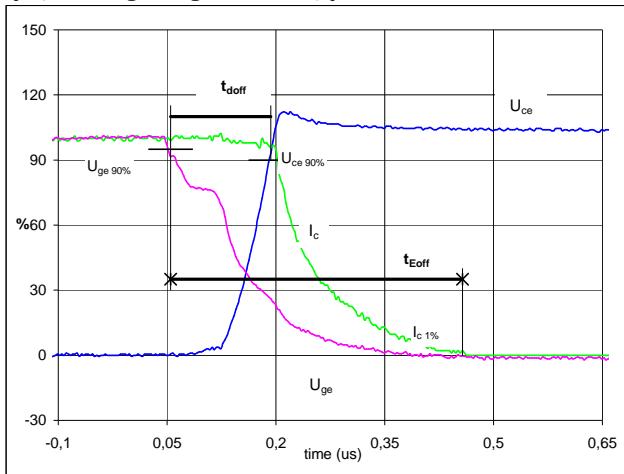
Switching Definitions Output Inverter

General conditions

| | |
|------------|----------|
| T_j | = 150 °C |
| R_{gon} | = 32 Ω |
| R_{goff} | = 32 Ω |

Figure 1

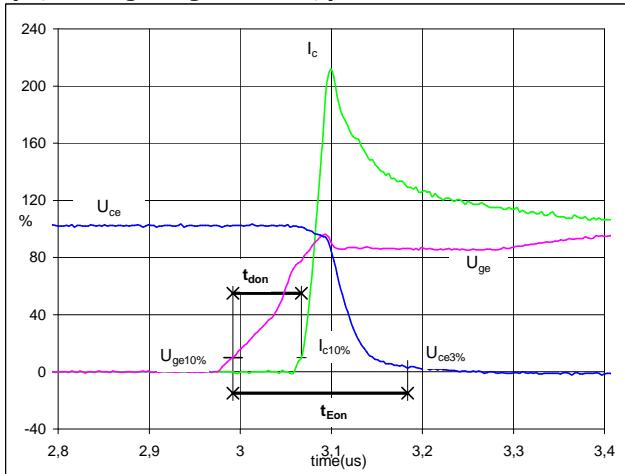
IGBT
Turn-off Switching Waveforms & definition of t_{doff} , t_{Eoff}
 $(t_{Eoff} = \text{integrating time for } E_{off})$



$V_{GE}(0\%) = -15$ V
 $V_{GE}(100\%) = 15$ V
 $V_C(100\%) = 300$ V
 $I_C(100\%) = 10$ A
 $t_{doff} = 0,13$ μs
 $t_{Eoff} = 0,40$ μs

Figure 2

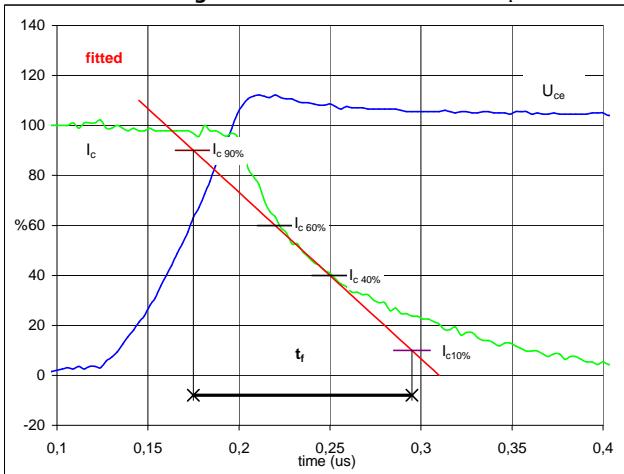
IGBT
Turn-on Switching Waveforms & definition of t_{don} , t_{Eon}
 $(t_{Eon} = \text{integrating time for } E_{on})$



$V_{GE}(0\%) = -15$ V
 $V_{GE}(100\%) = 15$ V
 $V_C(100\%) = 300$ V
 $I_C(100\%) = 10$ A
 $t_{don} = 0,07$ μs
 $t_{Eon} = 0,19$ μs

Figure 3

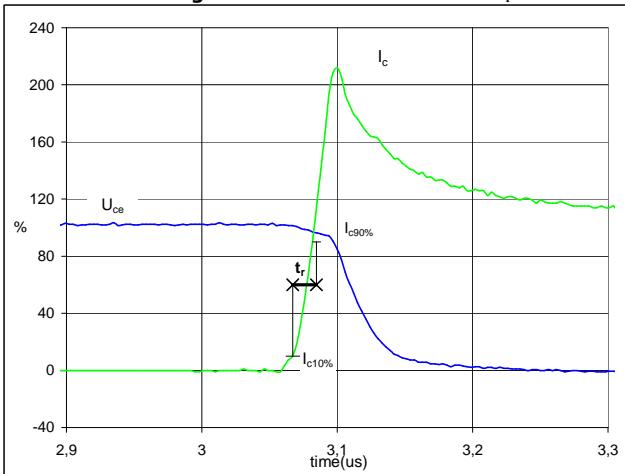
IGBT
Turn-off Switching Waveforms & definition of t_f



$V_C(100\%) = 300$ V
 $I_C(100\%) = 10$ A
 $t_f = 0,12$ μs

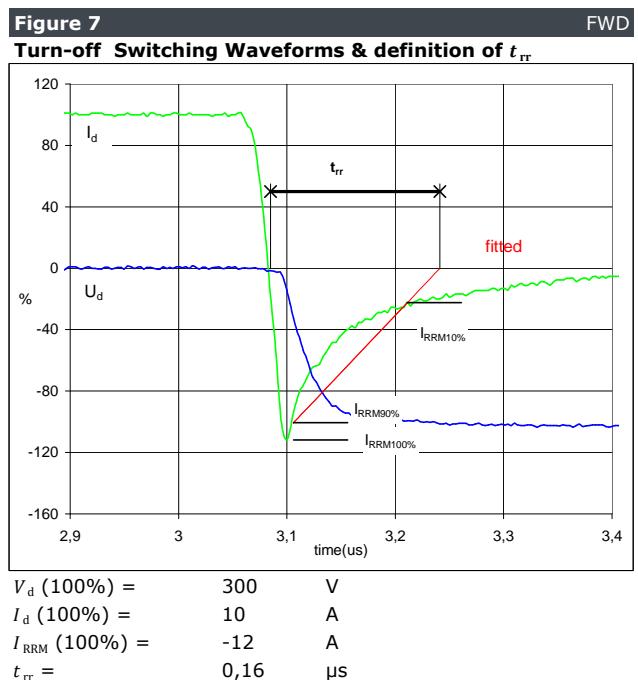
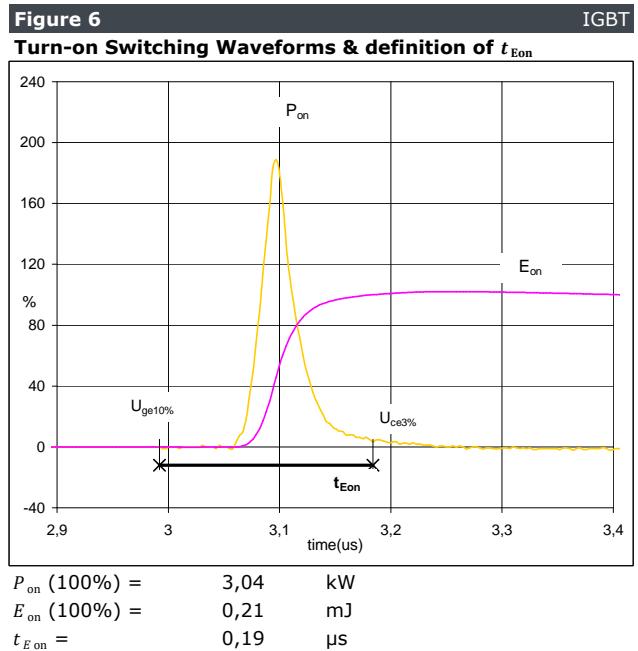
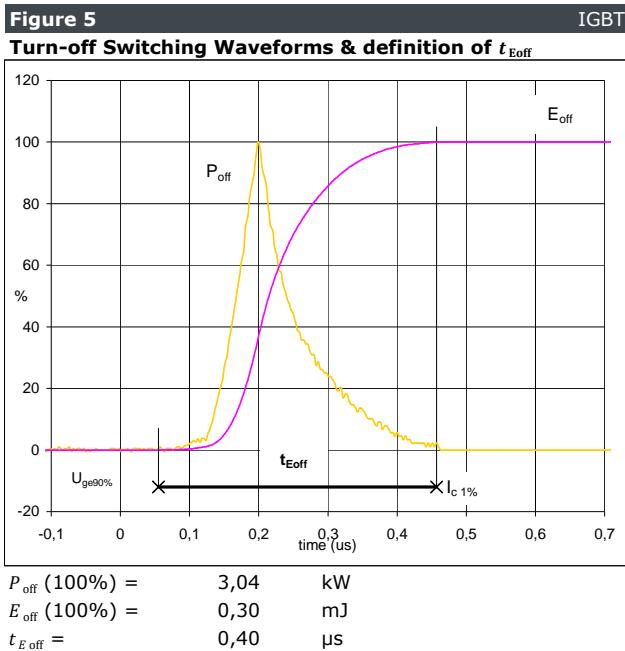
Figure 4

IGBT
Turn-on Switching Waveforms & definition of t_r

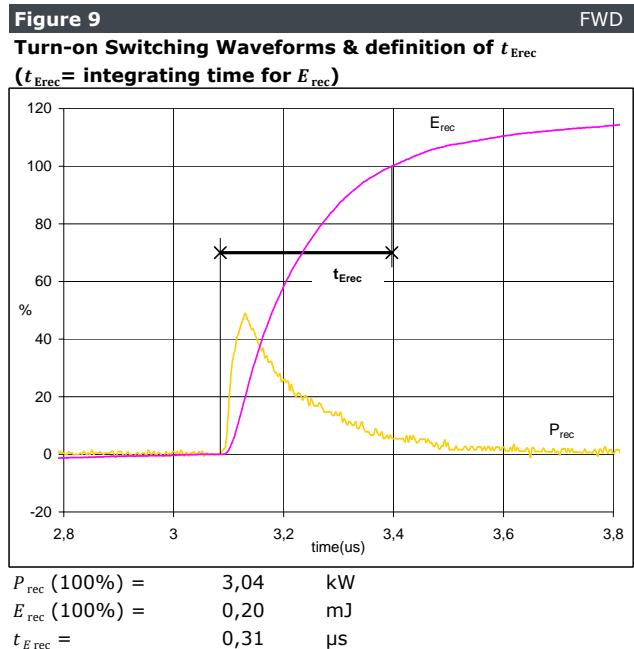
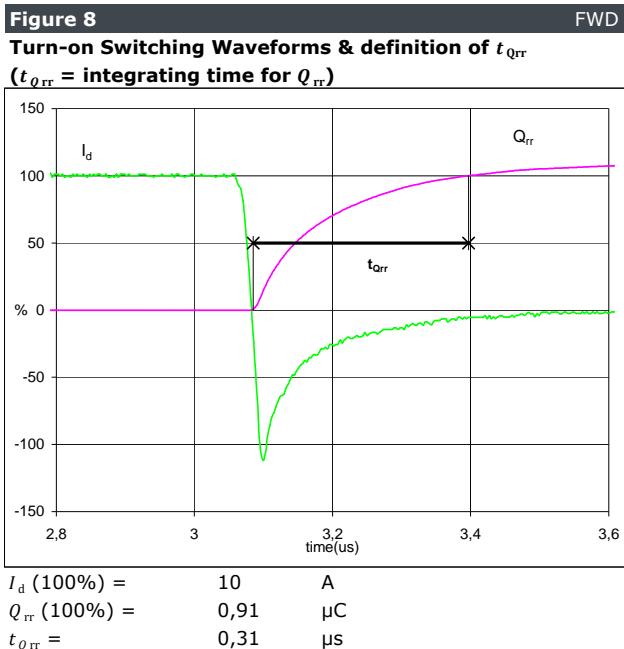


$V_C(100\%) = 300$ V
 $I_C(100\%) = 10$ A
 $t_r = 0,02$ μs

Switching Definitions Output Inverter



Switching Definitions Output Inverter

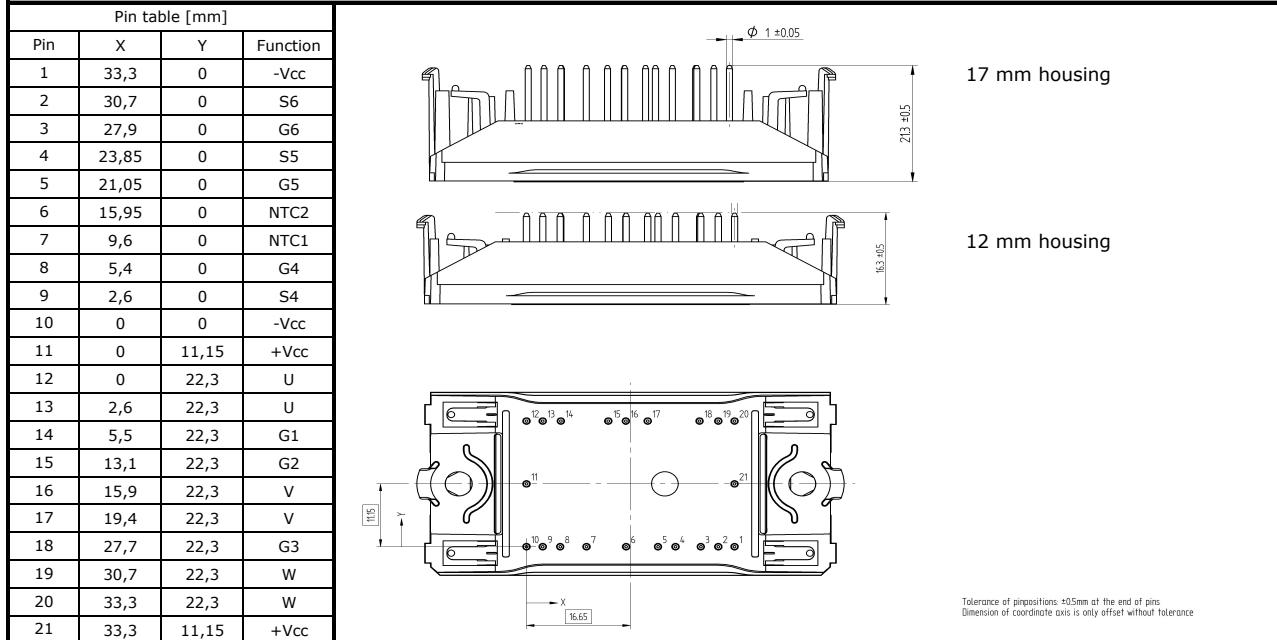


Ordering Code & Marking

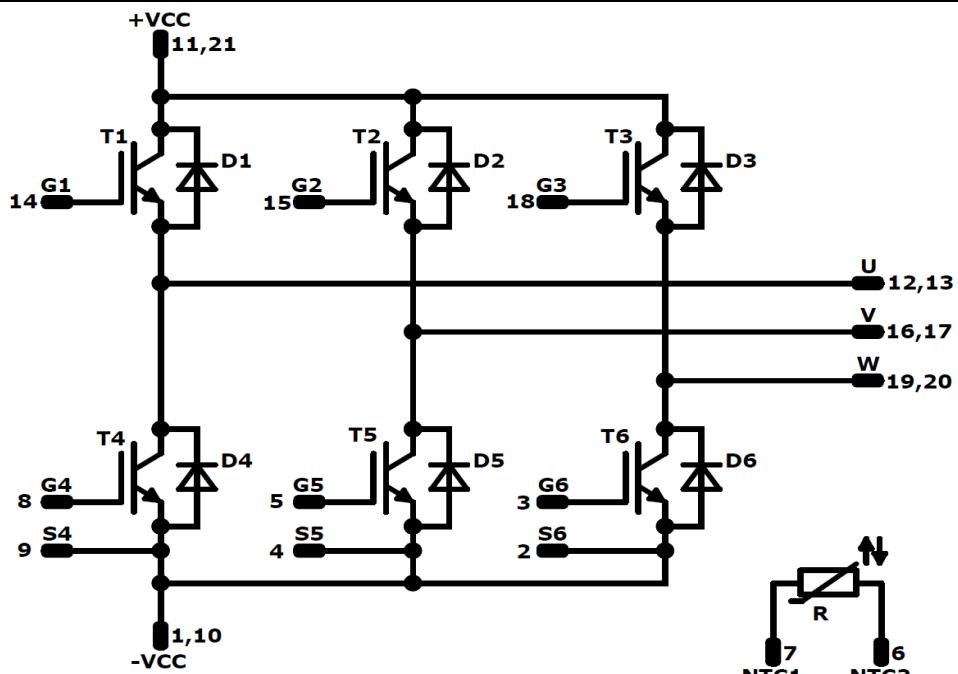
| Version | Ordering Code | | | | | |
|-------------------------------------|--------------------|------------|----------|-----------|-------|--------|
| without thermal paste 12 mm housing | V23990-P861-F48-PM | | | | | |
| without thermal paste 17 mm housing | V23990-P861-F49-PM | | | | | |
| Text | VIN | Date code | Name&Ver | UL | Lot | Serial |
| Datamatrix | VIN | WWYY | NNNNNNVV | UL | LLLLL | SSSS |
| | Type&Ver | Lot number | Serial | Date code | | |
| | TTTTTTVV | LLLLL | SSSS | WWYY | | |

VIN WWYY
NNNNNNVV UL
LLLLL SSSS

Outline



Pinout



Identification

| ID | Component | Voltage | Current | Function | Comment |
|------------------------|-----------|---------|---------|---------------------|---------|
| T1, T2, T3, T4, T5, T6 | IGBT | 600 V | 10 A | Inverter Transistor | |
| D1, D2, D3, D4, D5, D6 | FWD | 600 V | 10 A | Inverter Diode | |
| R | NTC | | | Thermistor | |



Vincotech

V23990-P861-F49-PM

V23990-P861-F48-PM

datasheet

| Packaging instruction | | >SPQ | Standard | <SPQ | Sample |
|-----------------------------------|-----|------|----------|------|--------|
| Standard packaging quantity (SPQ) | 135 | | | | |

| Handling instruction |
|--|
| Handling instructions for <i>flow</i> 0 packages see vincotech.com website. |

| Package data |
|---|
| Package data for <i>flow</i> 0 packages see vincotech.com website. |

| UL recognition and file number |
|--|
| This device is certified according to UL 1557 standard, UL file number E192116. For more information see vincotech.com website.  |

| Document No.: | Date: | Modification: | Pages |
|-----------------------|--------------|----------------------|--------------|
| V23990-P861-F4x-D3-14 | 28 Jan. 2018 | | |

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1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in labelling can be reasonably expected to result in significant injury to the user.
2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.